

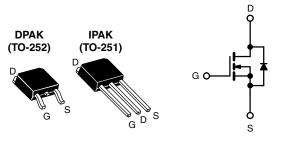
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Vishay Siliconix

COMPLIANT

HALOGEN FREE

Power MOSFET



N-Channel MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	100			
$R_{DS(on)}(\Omega)$	V _{GS} = 10 V	0.27		
Q _g max. (nC)	16			
Q _{gs} (nC)	4.4			
Q _{gd} (nC)	7.7			
Configuration	Single			

FEATURES

- · Dynamic dV/dt rating
- Repetitive avalanche rated
- Surface-mount (IRFR120, SiHFR120)
- Straight lead (IRFU120, SiHFU120)
- Available in tape and reel
- · Fast switching
- · Ease of paralleling
- Material categorization: for definitions of compliance please see <u>www.vishav.com/doc?99912</u>

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The DPAK is designed for surface mounting using vapor phase, infrared, or wave soldering techniques. The straight lead version (IRFU, SiHFU series) is for through-hole mounting applications. Power dissipation levels up to 1.5 W are possible in typical surface mount applications.

ORDERING INFORMATION						
PACKAGE	DPAK (TO-252)	DPAK (TO-252)	DPAK (TO-252)	DPAK (TO-252)	IPAK (TO-251)	
Load (Db) from	SiHFR120-GE3	SiHFR120TR-GE3 a	SiHFR120TRR-GE3 a	SiHFR120TRL-GE3 a	SiHFU120-GE3	
Lead (Pb)-free and halogen-free	IRFR120PbF-BE3	IRFR120TRPbF-BE3	IRFR120TRRPbF-BE3	IRFR120TRLPbF-BE3	-	
Lead (Pb)-free	IRFR120PbF	IRFR120TRPbF ^a	IRFR120TRRPbF ^a	IRFR120TRLPbF ^a	IRFU120PbF	

Notes

- a. See device orientation
- b. "-BE3" denotes alternate manufacturing location

ABSOLUTE MAXIMUM RATINGS (T _C	= 25 °C, unl	ess otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			V _{DS}	100	
Gate-source voltage			V_{GS}	± 20	V
Continuous drain current	V at 10 V	T _C = 25 °C T _C = 100 °C	-	7.7	
Continuous drain current	VGS at 10 V	T _C = 100 °C	I _D	4.9	Α
Pulsed drain current a			I _{DM}	31	
Linear derating factor				0.33	W/°C
Linear derating factor (PCB mount) e				0.020	\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\
Single pulse avalanche energy b			E _{AS}	210	mJ
Repetitive avalanche Current a			I _{AR}	7.7	Α
Repetitive avalanche Energy a			E _{AR}	4.2	mJ
Maximum power dissipation	T _C =	25 °C	ם	42	W
Maximum power dissipation (PCB mount) ^e T _A = 25 °C			P_{D}	2.5	VV
Peak diode recovery dV/dt ^c			dV/dt	5.5	V/ns
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C
Soldering recommendations (peak temperature) d	for	10 s	_	260	7

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. $V_{DD} = 25 \text{ V}$, starting $T_J = 25 \,^{\circ}\text{C}$, $L = 5.3 \,^{\circ}\text{mH}$, $R_g = 25 \,^{\circ}\Omega$, $I_{AS} = 7.7 \,^{\circ}\text{A}$ (see fig. 12).
- c. $I_{SD} \le 9.2$ A, $dI/dt \le 110$ A/µs, $V_{DD} \le V_{DS}$, $T_J \le 150$ °C.
- d. 1.6 mm from case.
- e. When mounted on 1" square PCB (FR-4 or G-10 material).

S21-0466-Rev. D, 17-May-2021 **1** Document Number: 91266

IRFR120, IRFU120, SiHFR120, SiHFU120

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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT
Maximum junction-to-ambient	R_{thJA}	=	-	110	
Maximum junction-to-ambient (PCB mount) a	R_{thJA}	-	-	50	°C/W
Maximum junction-to-case (drain)	R_{thJC}	-	-	3.0	

Note

a. When mounted on 1" square PCB (FR-4 or G-10 material).

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static							
Drain-source breakdown voltage	V _{DS}	V _{GS} :	= 0 V, I _D = 250 μA	100	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 1 mA	-	0.13	-	V/°C
Gate-source threshold voltage	V _{GS(th)}	V _{DS} =	· V _{GS} , I _D = 250 μA	2.0	-	4.0	V
Gate-source leakage	I _{GSS}		V _{GS} = ± 20 V	-	-	± 100	nA
Zero gate voltage drain current	I _{DSS}	V _{DS} =	: 100 V, V _{GS} = 0 V	-	-	25	μA
Zero gate voltage drain current	טיטו	$V_{DS} = 80 \text{ V}$	$V_{GS} = 0 \text{ V}, T_{J} = 125 ^{\circ}\text{C}$	-	-	250	μΛ
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	$I_D = 4.6 \text{ A}^b$	-	-	0.27	Ω
Forward transconductance	9 _{fs}	V _{DS}	= 50 V, I _D = 4.6 A	1.6	-	-	S
Dynamic							
Input capacitance	C _{iss}		V _{GS} = 0 V,	-	360	-	
Output capacitance	C _{oss}	1	$V_{DS} = 25 \text{ V},$	-	150	-	pF
Reverse transfer capacitance	C _{rss}	f = 1.0 MHz, see fig. 5		-	34	-	
Total gate charge	Q_g			-	-	16	
Gate-source charge	Q _{gs}	$V_{GS} = 10 \text{ V}$ $I_D = 9.2 \text{ A, } V_{DS} = 80 \text{ V,}$ see fig. 6 and 13 b		-	-	4.4	nC
Gate-drain charge	Q _{gd}			-	-	7.7	
Turn-on delay time	t _{d(on)}		•	-	6.8	-	
Rise time	t _r	$V_{DD} = 50 \text{ V, } I_D = 9.2 \text{ A,}$ $R_g = 18 \ \Omega, \ R_D = 5.2 \ \Omega, \ \text{see fig. 10} \ \text{b}$		-	27	-	ns ns
Turn-off delay time	t _{d(off)}			-	18	-	
Fall time	t _f			-	17	-	
Internal drain inductance	R _g	f = 1 MHz, open drain		1.0	-	5.0	Ω
Internal source inductance	L _D	Between lead	,2	-	4.5	-	
Input capacitance	L _S	6 mm (0.25") from package and center of die contact		-	7.5	-	nH
Drain-source body diode characteristics							
Continuous source-drain diode current	I _S	MOSFET s	ymbol	-	-	7.7	
Pulsed diode forward current ^a	I _{SM}	showing the integral reverse p - n junction diode		-	-	31	А
Body diode voltage	V_{SD}	T _J = 25 °C	$I_{S} = 7.7 \text{ A}, V_{GS} = 0 \text{ V}^{\text{ b}}$	-	-	2.5	V
Body diode reverse recovery time	t _{rr}	T 05 00 1	0.0 0 41/44 400 67 - 6	-	130	260	ns
Body diode reverse recovery charge	Q _{rr}	$I_J = 25 ^{\circ}\text{C}, I_F$	= 9.2 A, dl/dt = 100 A/µs b	-	0.65	1.3	μC
Forward turn-on time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by L_S and I			L _D)		

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width \leq 300 μ s; duty cycle \leq 2 %.

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

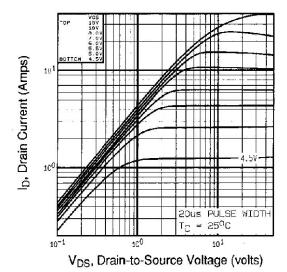


Fig. 1 - Typical Output Characteristics, $T_C = 25$ °C

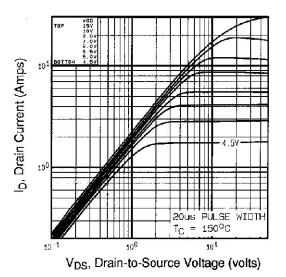
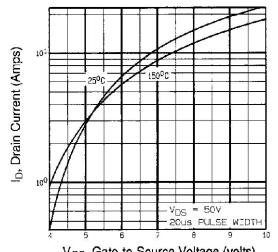


Fig. 2 - Typical Output Characteristics, T_C = 150 °C



V_{GS}, Gate-to-Source Voltage (volts)

Fig. 3 - Typical Transfer Characteristics

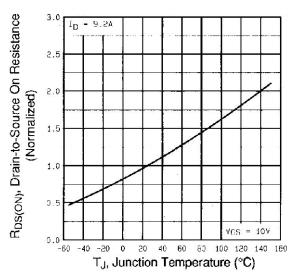


Fig. 4 - Normalized On-Resistance vs. Temperature

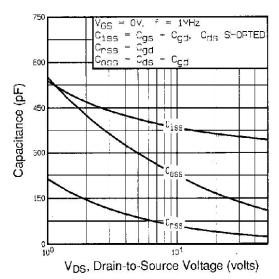


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

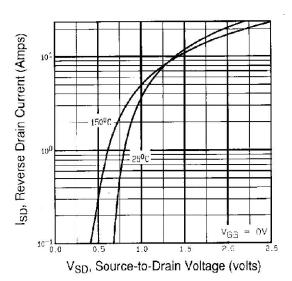


Fig. 7 - Typical Source-Drain Diode Forward Voltage

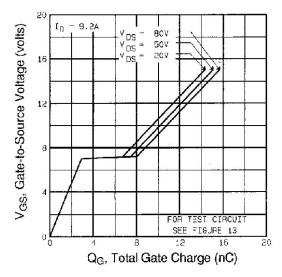


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

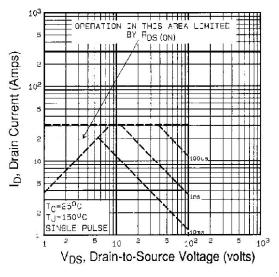


Fig. 8 - Maximum Safe Operating Area

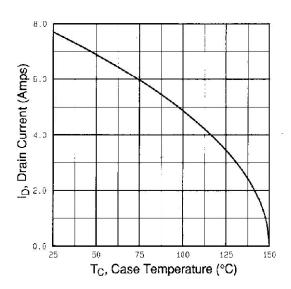


Fig. 9 - Maximum Drain Current vs. Case Temperature

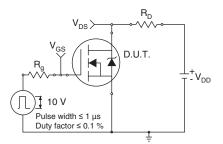


Fig. 10a - Switching Time Test Circuit

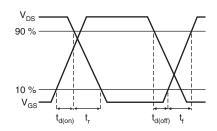


Fig. 10b - Switching Time Waveforms

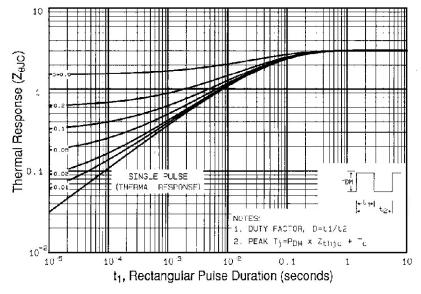


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

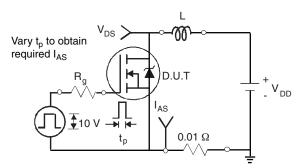


Fig. 12a - Unclamped Inductive Test Circuit

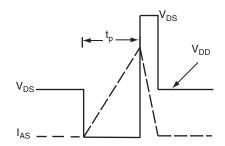


Fig. 12b - Unclamped Inductive Waveforms

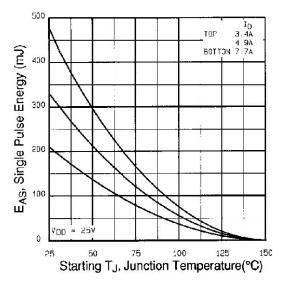


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

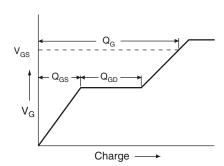


Fig. 13a - Basic Gate Charge Waveform

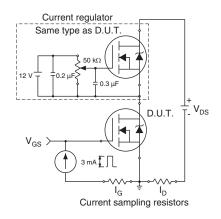
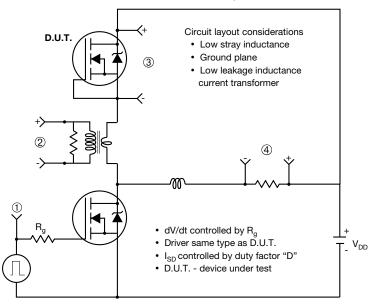


Fig. 13b - Gate Charge Test Circuit

Peak Diode Recovery dV/dt Test Circuit



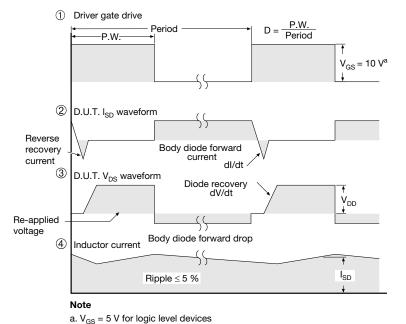


Fig. 14 - For N-Channel

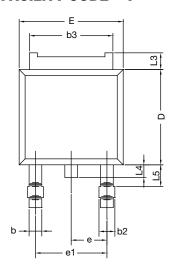
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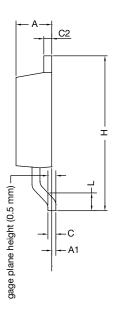


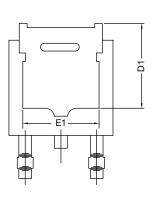
TO-252AA Case Outline

VERSION 1: FACILITY CODE = Y

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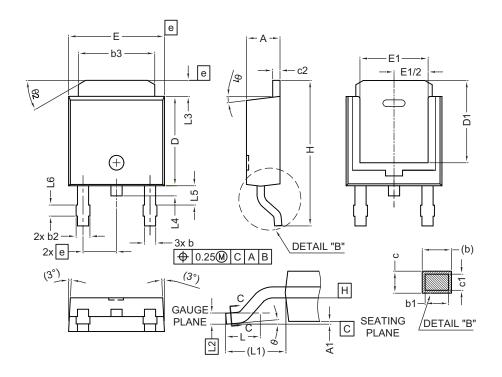
	MILLIN	METERS
DIM.	MIN.	MAX.
Α	2.18	2.38
A1	-	0.127
b	0.64	0.88
b2	0.76	1.14
b3	4.95	5.46
С	0.46	0.61
C2	0.46	0.89
D	5.97	6.22
D1	4.10	-
Е	6.35	6.73
E1	4.32	-
Н	9.40	10.41
е	2.28	BSC
e1	4.56	BSC
L	1.40	1.78
L3	0.89	1.27
L4	-	1.02
L5	1.01	1.52

Note

• Dimension L3 is for reference only



VERSION 2: FACILITY CODE = N



	MILLIMETERS		
DIM.	MIN.	MAX.	
Α	2.18	2.39	
A1	-	0.13	
b	0.65	0.89	
b1	0.64	0.79	
b2	0.76	1.13	
b3	4.95	5.46	
С	0.46	0.61	
c1	0.41	0.56	
c2	0.46	0.60	
D	5.97	6.22	
D1	5.21	=	
Е	6.35	6.73	
E1	4.32	=	
е	2.29 BSC		
Н	9.94	10.34	

	MILLIMETERS		
DIM.	MIN.	MAX.	
L	1.50	1.78	
L1	2.74	ref.	
L2	0.51 BSC		
L3	0.89	1.27	
L4	-	1.02	
L5	1.14	1.49	
L6	0.65	0.85	
θ	0°	10°	
θ1	0°	15°	
θ2	25°	35°	

Notes

- Dimensioning and tolerance confirm to ASME Y14.5M-1994
- All dimensions are in millimeters. Angles are in degrees
- Heat sink side flash is max. 0.8 mm
- · Radius on terminal is optional

ECN: E19-0649-Rev. Q, 16-Dec-2019

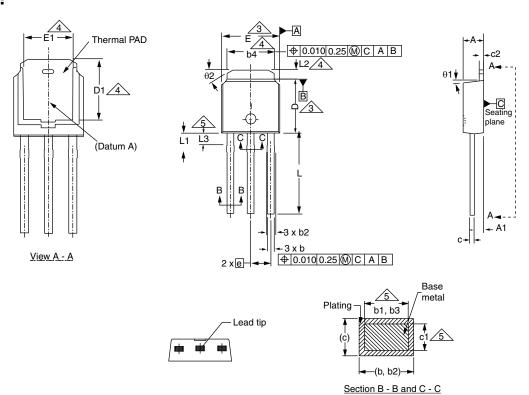
DWG: 5347

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Case Outline for TO-251AA (High Voltage)

OPTION 1:



	MILLIMETERS		INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
Α	2.18	2.39	0.086	0.094
A1	0.89	1.14	0.035	0.045
b	0.64	0.89	0.025	0.035
b1	0.65	0.79	0.026	0.031
b2	0.76	1.14	0.030	0.045
b3	0.76	1.04	0.030	0.041
b4	4.95	5.46	0.195	0.215
С	0.46	0.61	0.018	0.024
c1	0.41	0.56	0.016	0.022
c2	0.46	0.86	0.018	0.034
D	5.97	6.22	0.235	0.245

	MILLIM	IETERS	INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
D1	5.21	-	0.205	-
Е	6.35	6.73	0.250	0.265
E1	4.32	=	0.170	=
е	2.29	2.29 BSC		BSC
L	8.89	9.65	0.350	0.380
L1	1.91	2.29	0.075	0.090
L2	0.89	1.27	0.035	0.050
L3	1.14	1.52	0.045	0.060
θ1	0'	15'	0'	15'
θ2	25'	35'	25'	35'
	•		•	

ECN: E21-0682-Rev. C, 27-Dec-2021

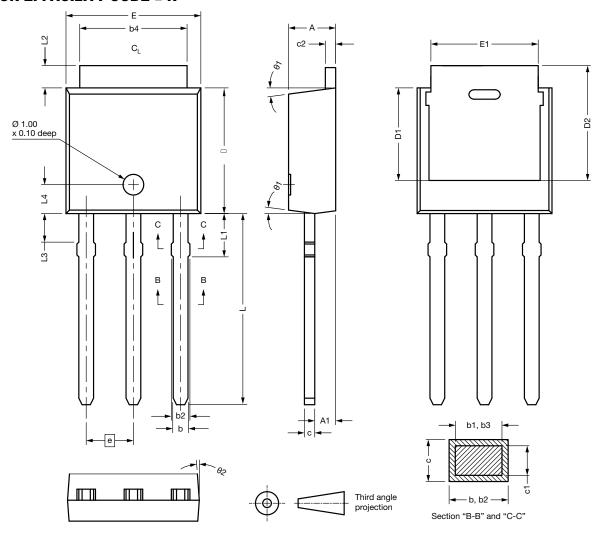
DWG: 5968

Notes

- Dimensioning and tolerancing per ASME Y14.5M-1994
- Dimension are shown in inches and millimeters
- Dimension D and E do not include mold flash. Mold flash shall not exceed 0.13 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- Thermal pad contour optional with dimensions b4, L2, E1 and D1
- Lead dimension uncontrolled in L3
- Dimension b1, b3 and c1 apply to base metal only
- Outline conforms to JEDEC® outline TO-251AA



OPTION 2: FACILITY CODE = N



DIM.	MIN.	NOM.	MAX.
Α	2.180	2.285	2.390
A1	0.890	1.015	1.140
b	0.640	0.765	0.890
b1	0.640	0.715	0.790
b2	0.760	0.950	1.140
b3	0.760	0.900	1.040
b4	4.950	5.205	5.460
С	0.460	-	0.610
c1	0.410	-	0.560
c2	0.460	-	0.610
D	5.970	6.095	6.220
D1	4.300	-	-

DIM.	MIN.	NOM.	MAX.
D2	5.380	-	-
E	6.350	6.540	6.730
E1	4.32	-	-
е	2.29	BSC	
L	8.890	9.270	9.650
L1	1.910	2.100	2.290
L2	0.890	1.080	1.270
L3	1.140	1.330	1.520
L4	1.300	1.400	1.500
θ1	0°	7.5°	15°
θ2	4°	-	-

ECN: E21-0682-Rev. C, 27-Dec-2021

DWG: 5968

- Dimensioning and tolerancing per ASME Y14.5M-1994
- All dimension are in millimeters, angles are in degrees
- Heat sink side flash is max. 0.8 mm



RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

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